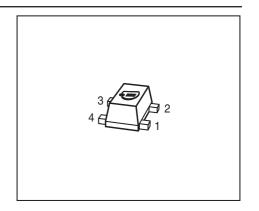


### Low Noise Silicon Bipolar RF Transistor

- For ESD protected high gain low noise amplifier
- Excellent ESD performance typical value 1000 V (HBM)
- Outstanding G<sub>ms</sub> = 20 dB
   Minimum noise figure NF<sub>min</sub> = 0.9 dB
- Pb-free (ROHS compliant) and halogen-free thin small flat package with visible leads
- Qualification report according to AEC-Q101 available







## ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration				Package		
BFP540FESD	AUs	1=B	2=E	3=C	4=E	-	-	TSFP-4

# **Maximum Ratings** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$		V
<i>T</i> <sub>A</sub> = 25 °C		4.5	
<i>T</i> <sub>A</sub> = -55 °C		4	
Collector-emitter voltage	$V_{CES}$	10	
Collector-base voltage	$V_{\mathrm{CBO}}$	10	
Emitter-base voltage	V <sub>EBO</sub>	1	
Collector current	$I_{\mathbb{C}}$	80	mA
Base current	l <sub>B</sub>	8	
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	250	mW
<i>T</i> <sub>S</sub> ≤ 80 °C			
Junction temperature	$T_{J}$	150	°C
Storage temperature	$T_{\mathrm{Stg}}$	-55 150	

1

 $<sup>{}^1</sup>T_{
m S}$  is measured on the emitter lead at the soldering point to the pcb



### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	280	K/W

# **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	,	•	•		•
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	4.5	5	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0	, ,				
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	10	μA
$V_{CE} = 10 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB} = 5 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	10	μA
$V_{\rm EB} = 0.5  \rm V,  I_{\rm C} = 0$					
DC current gain	h <sub>FE</sub>	50	110	170	-
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 3.5 V, pulse measured					

 $<sup>^{1}</sup>$ For the definition of  $R_{thJS}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

2



**Electrical Characteristics** at  $T_A$  = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1	Т	Г	1
Transition frequency	$f_{T}$	21	30	-	GHz
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 4 V, $f$ = 1 GHz					
Collector-base capacitance	C <sub>cb</sub>	-	0.16	0.26	pF
$V_{\text{CB}} = 2 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0 ,$					
emitter grounded					
Collector emitter capacitance	C <sub>ce</sub>	-	0.4	-	
$V_{CE} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
base grounded					
Emitter-base capacitance	C <sub>eb</sub>	-	0.55	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$ ,					
collector grounded					
Minimum noise figure	NF <sub>min</sub>				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 2 V, $f$ = 1.8 GHz, $Z_{\rm S}$ = $Z_{\rm Sopt}$		-	0.9	1.4	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 2 V, $f$ = 3 GHz, $Z_{\rm S}$ = $Z_{\rm Sopt}$		-	1.3	-	
Power gain, maximum stable <sup>1)</sup>	G <sub>ms</sub>	-	20	-	dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,					
$Z_{L} = Z_{Lopt}$ , $f = 1.8 \text{ GHz}$					
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>	-	14.5	-	dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,					
$Z_{L} = Z_{Lopt}, f = 3 \text{ GHz}$					
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ , $f$ = 1.8GHz		15.5	18	-	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ , $f$ = 3GHz		_	13	-	
Third order intercept point at output <sup>2)</sup>	IP3	-	24.5	-	dBm
$V_{CE}$ = 2 V, $I_{C}$ = 20 mA, $Z_{S}$ = $Z_{L}$ = 50 $\Omega$ , $f$ = 1.8GHz					
1dB compression point at output	P <sub>-1dB</sub>	-	11	-	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ , $f$ = 1.8GHz					

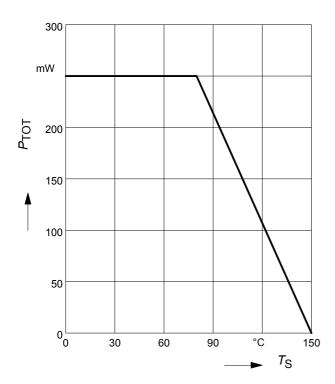
 $<sup>^{1}</sup>G_{\text{ma}} = |S_{21e} / S_{12e}| (k-(k^{2}-1)^{1/2}), G_{\text{ms}} = |S_{21e} / S_{12e}|$ 

 $<sup>^2\</sup>mbox{IP3}$  value depends on termination of all intermodulation frequency components.

Termination used for this measurement is  $50\Omega$  from 0.1 MHz to 6 GHz



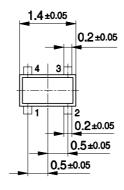
# Total power dissipation $P_{tot} = f(T_S)$

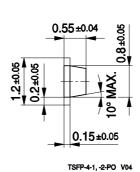




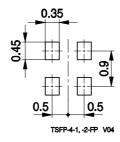
# Package Outline



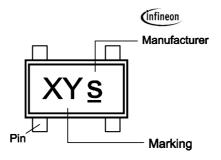




# **Foot Print**

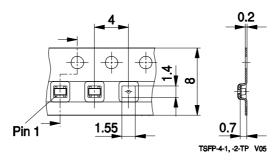


# Marking Layout (Example)



# Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

### Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<a href="www.infineon.com">www.infineon.com</a>).

### Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

6

2013-09-05

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# Infineon:

BFP 540FESD H6327 BFP 540FESD E6327 BFP540FESDH6327XTSA1